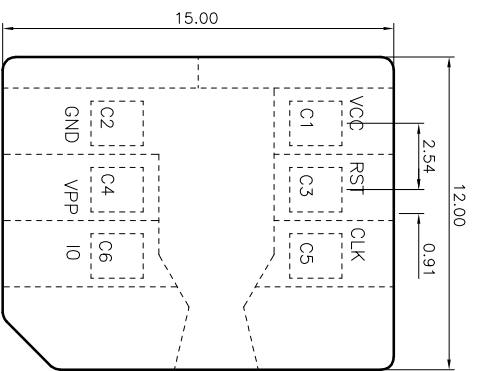
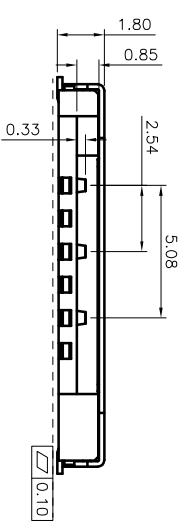
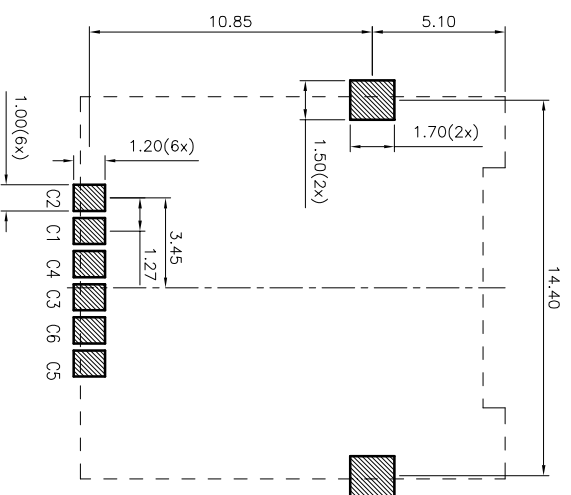
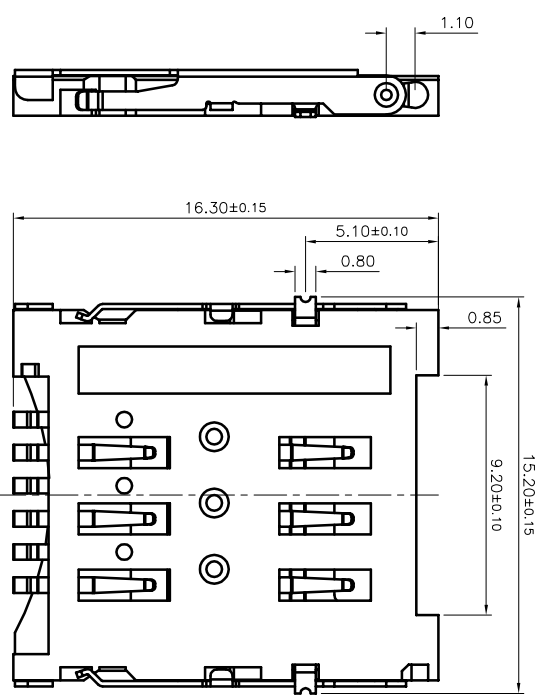
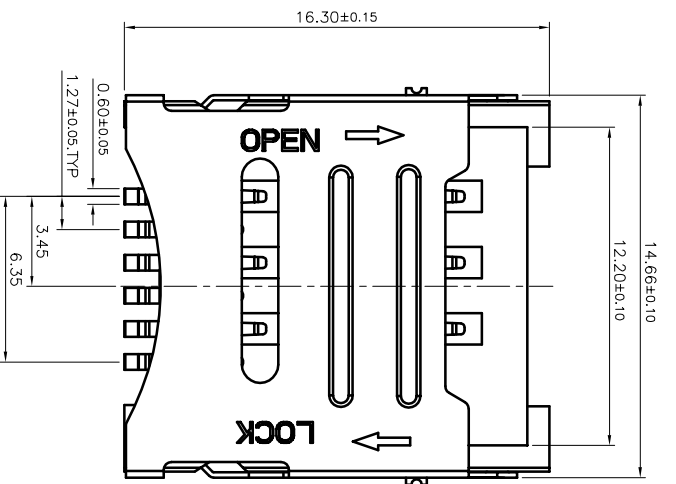


| REV. | ECN NO OR DESCRIPTION | REVISED | DATE |
|------|-----------------------|---------|------------|
| 1 | PROPOSE ONLY | ALLEN | 2011.04.08 |

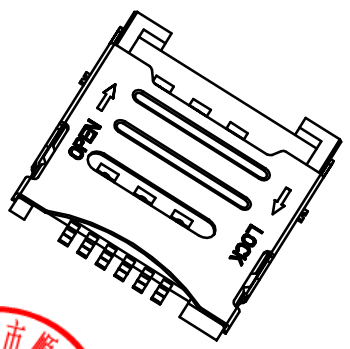


-NOTE-

- *Electrical Characteristics:
Contact Current Rating:0.5 Amperes.
Dielectric Withstanding Voltage:AC500V r.m.s.
Insulation Resistance:1000 MΩ Minimum.
Contact Resistance:40 mΩ Maximum.
- *Environmental:
Operating Temperature:-25°C+90°C.
- *Environmental:
Mating Cycles:3,000 Insertions.
- *Mechanical Characteristics:
Card Push Insertion/Out Force:0.7N±0.20kgf.
Contact Separation Force:0.20kgf Minimum.
- *Material:
Insulator:HI-Temp Plastic UL 94V-0 Rated.
Contact:Copper Alloy(t=0.15mm).
Shell:Stainless Steel(t=0.15mm).

3. PART No.: S O HG - 18 00 06 - 03 G

- SIM CARD
- 0=WITHOUT POST
- HG=HINGE Type.
- 18:HEIGHT 1.8mm
- G=gold flash
- 03=Product Order
- Pin NO. 6=6Pin
- 00=NORMAL TYPE.



RECOMMENDED P.C. BOARD LAYOUT(TOP VIEW)
GENERAL TOLERANCE:±0.05



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| NO. | DESCRIPTION | QTY | MATERIAL | NOTE |
|-----|-------------|-----|-----------------|----------------------|
| 3 | TERMINAL | 6 | COPPER ALLOY | CONTACT Au OVER ALL. |
| 2 | SHELL | 1 | STAINLESS STEEL | |
| 1 | HOUSING | 1 | THERMOPLASTIC | UL 94V-0 |

| UNLESS OTHERWISE SPECIFIED TOLERANCES | | ANGLES: | |
|---------------------------------------|-------|---------|-----|
| DECIMALS: | ±0.5 | X | ±2° |
| X.X | ±0.20 | X.X | ±1° |
| X.XX | ±0.10 | | |

| TITLE | 1.8H HINGE MICRO SIM CARD CONN |
|-------|--------------------------------------|
| DWN | ALLEN PART NO. SHK-10365 |
| CHKD | KEVIN SCALE:1:1 UNIT: mm |
| APVD | ERIC.W SIZE: A3 SHEET:1 OF 1 REV: A1 |

CUSTOMER COPY